Application No.: Amendment dated: 10/755,584 July 13, 2004

Reply to Office Action of:

May 12, 2004

Amendments to the Specification:

Please replace the paragraph, beginning at page 1, line 5, with the following rewritten paragraph:

The present invention relates to a screen printing apparatus which prints paste, e.g., cream solder or conductive paste, onto a substrate, and a method of the screen printing. More particularly, it relates to a novel squeegee head of the apparatus. The head can maintain fluidity of the paste and prevent defective printing due to hardened paste, and the method of screen printing using the same apparatus.

Please replace the paragraph, beginning at page 7, line 11, with the following rewritten paragraph:

Movement of solder 5 in cell 35 is demonstrated with reference to Fig. 4. As shown in Fig. 4, when solder 5 moves downward in cell 35, rectifier 34 blocks solder 5 from flowing into a specific area, i.e., the area just above opening 37. This structure forces solder 5 to go around rectifier 34 to get to opening 37, and slopes 361 and 362 restrict the flow direction so that solder 5 flows slantingly into opening 37 as arrow marks 100 indicate. The flow-in direction is restricted to a slant direction as shown in Fig. 4, and solder 5 thus cannot flow in from above opening 37.